

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Byung-Sung Kwak	06/25/2011
Stefan Bangert	06/22/2011
Dieter Haas	07/06/2011
Omkaram Nalamasu	06/27/2011
RECEIVING PARTY DATA	
Name:	Applied Materials, Inc.
Street Address:	3050 Bowers Avenue
City:	Santa Clara
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13157651
CORRESPONDENCE DATA	
Fax Number:	(503)439-6073
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(503) 439-8778
Email:	gigi_hoover@bstz.com
Correspondent Name:	Justin K. Brask
Address Line 1:	1279 Oakmead Parkway
Address Line 4:	Sunnyvale, CALIFORNIA 94085-4040
ATTORNEY DOCKET NUMBER:	4887.P1024
NAME OF SUBMITTER:	Justin K. Brask

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Total Attachments: 8
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ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Byung-Sung Kwak 9723 NW Henry Ct. Portland, OR 97229	2)	Stefan Bangert Seidenroetherstrasse 6 Steinau, DE 36396
3)	Dieter Haas 3309 Patina Ct. San Jose, CA 95135	4)	Omikaram Nalamasu 2339 Bentley Ridge Drive San Jose, CA 95138

(hereinafter referred to as Assignors), have invented a certain invention entitled:

METHODS OF AND HYBRID FACTORIES FOR THIN-FILM BATTERY MANUFACTURING

for which application for Letters Patent in the United States was filed on June 10, 2011, under Serial No. 13/157,651, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

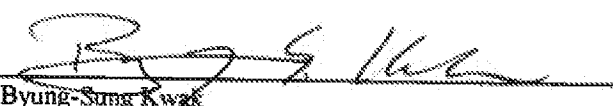
2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that

the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

- 1) June 25, 2011
Date 
Byung-Sung Kwak

- 2) _____
Date Stefan Bangert

- 3) _____
Date Dieter Haas

- 4) _____
Date Omkaram Nalamasu

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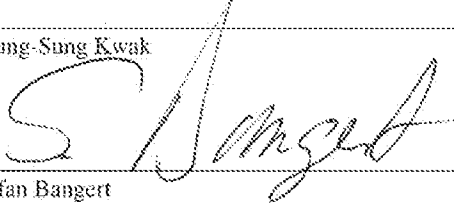
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1) Date Byung-Sung Kwak
2)	<u>06/22/2011</u> Date	 Stefan Bangert
3) Date Dieter Haas
4) Date Onkaram Nalamasu

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1)	_____	_____
	Date	Byung-Sung Kwak
2)	_____	_____
	Date	Stefan Bangert
3)	<u>07/06/2011</u>	<u>Dieter Haas</u>
	Date	Dieter Haas
4)	_____	_____
	Date	Omkaram Nalamasu

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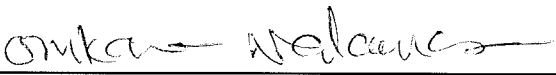
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	Date	Byung-Sung Kwak
2)	_____	_____
	Date	Stefan Bangert
3)	_____	_____
	Date	Dieter Haas
4)	08/27/2011	
	Date	Omkaram Nalamasu